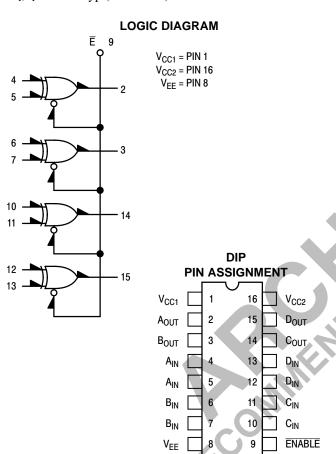
Quad Exclusive OR Gate

The MC10113 is a quad Exclusive OR gate, with an enable common to all four gates. The outputs may be wire-ORed together to perform a 4—bit comparison function (A = B). The enable is active low.

- $P_D = 175 \text{ mW typ/pkg (No Load)}$
- $t_{pd} = 2.5 \text{ ns typ}$
- t_r , $t_f = 2.0$ ns typ (20%–80%)



Pin assignment is for Dual-in-Line Package. For PLCC pin assignment, see the Pin Conversion Tables on page 18 of the ON Semiconductor MECL Data Book (DL122/D).

TRUTH TABLE

	TRUTH TABLE					
. 5	Ē	٧	Ē	OUTPUT		
	L	L	L	L		
	L	Н	L	Н		
	Н	L	L	Н		
	Н	Н	L	L		
	Χ	Χ	Н	L		
O.						



ON Semiconductor

http://onsemi.com

MARKING DIAGRAMS



CDIP-16 **L SUFFIX CASE 620**





PDIP-16 P SUFFIX **CASE 648**





PLCC-20 **FN SUFFIX CASE 775**



= Assembly Location

WL = Wafer Lot YY = Year WW = Work Week

ORDERING INFORMATION

Device	Package	Shipping
MC10113L	CDIP-16	25 Units / Rail
MC10113P	PDIP-16	25 Units / Rail
MC10113FN	PLCC-20	46 Units / Rail

ELECTRICAL CHARACTERISTICS

Characteristic Power Supply Drain Current Input Current		Pin	Test Limits						+85°C		
Power Supply Drain Current		Under		1		+25°C	ī		1		
	Symbol	Test	Min	Max	Min	Тур	Max	Min	Max	U	
Input Current	Ι _Ε	8		46			42		46	m	
•	I _{inH}	4,7,10,13 5,6,11,12		425 350			265 220		265 220	μA	
		9		870			545		545		
	l _{inL}	*	0.5		0.5			0.3		μA	
Output Voltage Logic 1		2	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	V	
		3	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700		
		14 15	-1.060 -1.060	-0.890 -0.890	-0.960 -0.960		-0.810 -0.810	-0.890 -0.890	-0.700 -0.700		
Output Voltage Logic 0	V _{OL}	2	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	V	
- Logic o	- OL	3	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615		
		14	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615		
		15	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615		
Threshold Voltage Logic 1	V _{OHA}	2 3	-1.080 -1.080		-0.980 -0.980			-0.910 -0.910		V	
		14	-1.080		-0.980			-0.910			
		15	-1.080		-0.980			-0.910			
Threshold Voltage Logic 0	V_{OLA}	2		-1.655			-1.630		-1.595	V	
		3 14		-1.655 -1.655			-1.630 -1.630		-1.595 -1.595		
		15		-1.655			-1.630		-1.595		
Switching Times (50Ω Load)					Min	Тур	Max			r	
Propagation Delay	t ₄₊₂₊	2	1.1	4.7	1.3	2.6	4.5	1.3	5.0		
	t ₄₋₂₋	2	1.1	4.7	1.3	2.6	4.5	1.3	5.0		
	t ₉₊₂₋	2 2	1.3 1.3	5.2 5.2	1.5 1.5	3.4 3.4	5.0 5.0	1.5 1.5	5.5 5.5		
Rise Time (20 to 80%)	t ₉₋₂₊	2	1.1	4.2	1.1	2.5	3.9	1.1	4.4		
Fall Time (20 to 80%)		2	1.1	4.2	1.1	2.5	3.9	1.1	4.4		
Individually test each input a	=					2.0	0.0		7.7		
OFNICE	51.04	CO									

ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)						
		@ Test Te	mperature	V _{IHmax}	V_{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}	
			-30°C	-0.890	-1.890	-1.205	-1.500	-5.2	
			+25°C	-0.810	-1.850	-1.105	-1.475	-5.2	
			+85°C	-0.700	-1.825	-1.035	-1.440	-5.2	
	Pin			TEST VOLTAGE APPLIED TO PINS LISTED BELOW					
Characteristic		Symbol	Under Test	V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}	(V _{CC}) Gnd
Power Supply Drain C	Current	ΙE	8					8	1, 16
Input Current		l _{inH}	4,7,10,13 5,6,11,12 9	* * 9				8 8 8	1, 16 1, 16 1, 16
		I _{inL}	*		*			8	1, 16
Output Voltage	Logic 1	V _{OH}	2 3 14 15	4 7 11 13				8 8 8	1, 16 1, 16 1, 16 1, 16
Output Voltage	Logic 0	V _{OL}	2 3 14 15		4 7 11 13		W.	8 8 8 8	1, 16 1, 16 1, 16 1, 16
Threshold Voltage	Logic 1	V _{OHA}	2 3 14 15			4 6 10 12		8 8 8	1, 16 1, 16 1, 16 1, 16
Threshold Voltage	Logic 0	V _{OLA}	2 3 14 15	X			5 7 11 13	8 8 8 8	1, 16 1, 16 1, 16 1, 16
Switching Times	(50Ω Load)			+1.11V		Pulse In	Pulse Out	-3.2 V	+2.0 V
Propagation Delay	,	t ₄₊₂₊ t ₄₋₂₋ t ₉₊₂₋ t ₉₋₂₊	2 2 2 2	4 4)	4 4 9 9	2 2 2 2	8 8 8	1, 16 1, 16 1, 16 1, 16
Rise Time	(20 to 80%)	t ₂₊	2			4	2	8	1, 16
Fall Time	(20 to 80%)	t ₂₋	2			4	2	8	1, 16

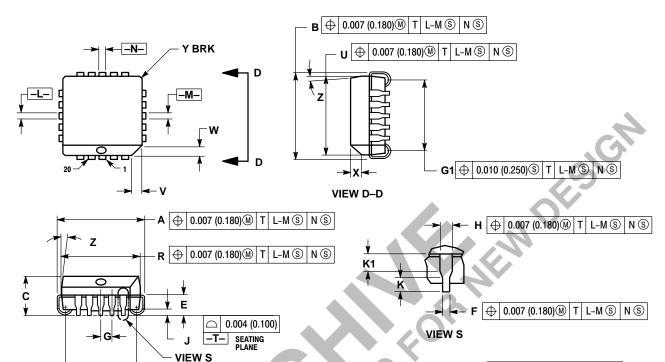
^{*} Individually test each input applying V_{IH} or V_{IL} to input under test.

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50–ohm resistor to –2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

PACKAGE DIMENSIONS

PLCC-20 **FN SUFFIX**

PLASTIC PLCC PACKAGE CASE 775-02 ISSUE C



NOTES:

G1 ⊕ 0.010 (0.250)③ T L-M ⑤ N ⑤

OF MICE. NOT PERSON

- IOTES:

 1. DATUMS -L-, -M-, AND -N- DETERMINED WHERE TOP OF LEAD SHOULDER EXITS PLASTIC BODY AT MOLD PARTING LINE.

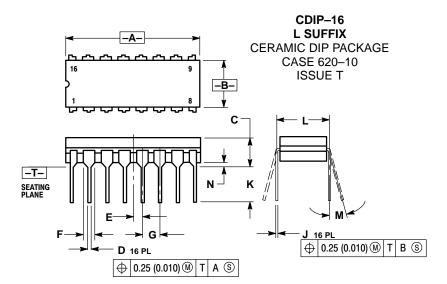
 2. DIMENSION G1, TRUE POSITION TO BE MEASURED AT DATUM -T-, SEATING PLANE.

 3. DIMENSIONS R AND U DO NOT INCLUDE MOLD FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.

 4. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M. 1982.
- Y14.5M, 1982. CONTROLLING DIMENSION: INCH.
- THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
- DIMENSION H DOES NOT INCLUDE DAMBAR PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

	INC	HES	MILLIM	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.385	0.395	9.78	10.03
В	0.385	0.395	9.78	10.03
С	0.165	0.180	4.20	4.57
Е	0.090	0.110	2.29	2.79
F	0.013	0.019	0.33	0.48
G	0.050	BSC	1.27	BSC
Н	0.026	0.032	0.66	0.81
J	0.020		0.51	
K	0.025		0.64	
R	0.350	0.356	8.89	9.04
U	0.350	0.356	8.89	9.04
٧	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
X	0.042	0.056	1.07	1.42
Υ		0.020		0.50
Z	2°	10°	2°	10 °
G1	0.310	0.330	7.88	8.38
K1	0.040		1.02	

PACKAGE DIMENSIONS



NOTES:

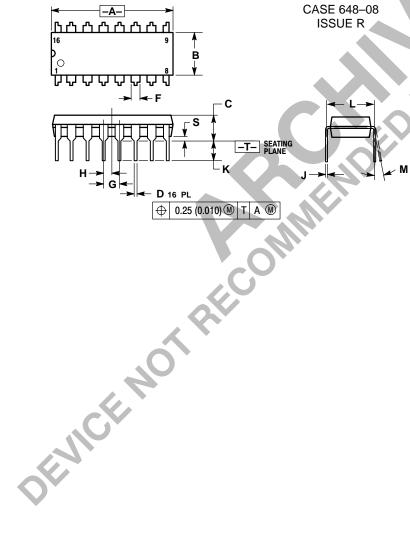
- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 CONTROLLING DIMENSION: INCH.
 DIMENSION LTO CENTER OF LEAD WHEN CONTROLLING DIMENSION LTO CENTER OF LEAD WHEN

- FORMED PARALLEL

 DIMENSION F MAY NARROW TO 0.76 (0.030)
 WHERE THE LEAD ENTERS THE CERAMIC
 BODY.

	INC	HES	MILLIN	IETERS	
DIM	MIN MAX		MIN	MAX	
Α	0.750	0.785	19.05	19.93	
В	0.240	0.295	6.10	7.49	
С		0.200		5.08	
D	0.015	0.020	0.39	0.50	
Е	0.050	BSC	1.27 BSC		
F	0.055	0.065	1.40	1.65	
G	0.100	BSC	2.54 BSC		
Н	0.008	0.015	0.21	0.38	
K	0.125	0.170	3.18	4.31	
L	0.300	BSC	7.62 BSC		
M	0 °	15°	0 °	15°	
N	0.020	0.040	0.51	1.01	





- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
 4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
 5. ROUNDED CORNERS OPTIONAL

	INC	HES	MILLIN	IETERS
DIM	MIN	MIN MAX		MAX
Α	0.740	0.770	18.80	19.55
В	0.250	0.270	6.35	6.85
C	0.145	0.175	3.69	4.44
D	0.015	0.021	0.39	0.53
F	0.040	0.70	1.02	1.77
G	0.100	BSC	2.54	BSC
Н	0.050	BSC	1.27	BSC
J	0.008	0.015	0.21	0.38
K	0.110	0.130	2.80	3.30
L	0.295	0.305	7.50	7.74
M	0°	10°	0°	10 °
S	0.020	0.040	0.51	1.01

Notes



Notes





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